



Product Summary

Device	BV _{DSS}	R _{DS(ON)} max	l _D max T _A = +25°C
N-	2014	0.4Ω @ V _{GS} = 10V	0.8A
Channel	30V	0.7Ω @ V _{GS} = 4.5V	0.57A

DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

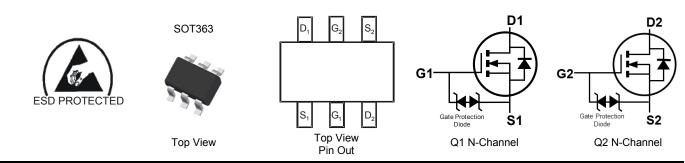
Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor Control
- Power Management Functions
- DC-DC Converters

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.027 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3401LDW-7	SOT363	3000/Tape & Reel
DMN3401LDW-13	SOT363	10000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

	7 Г				
	01		-	М	
MY			10)4	

401 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} or \underline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Notes:

Date Code Key												
Year	2018		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	F		I	J	K	L	М	Ν	0	Р	R	S
Month	Jan	Feb	Mar	Apr	Mav	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	30	V	
Gate-Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		ID	0.8 0.6	А
Maximum Continuous Body Diode Forward Current	ls	0.4	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	4	A	

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.29	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	433	°C/W
Total Power Dissipation (Note 6)		PD	0.35	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	360	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

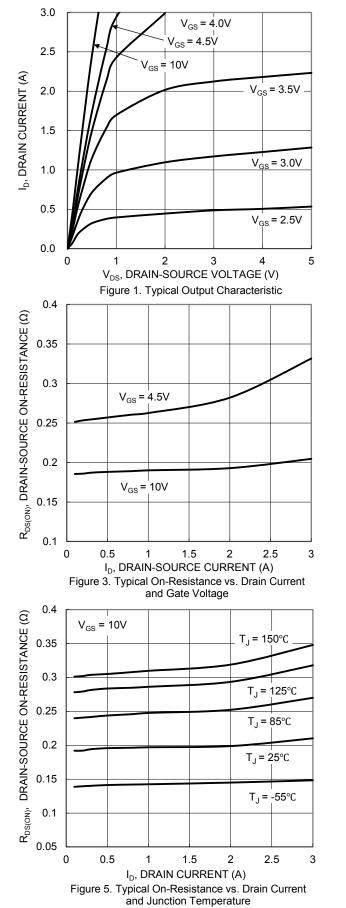
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

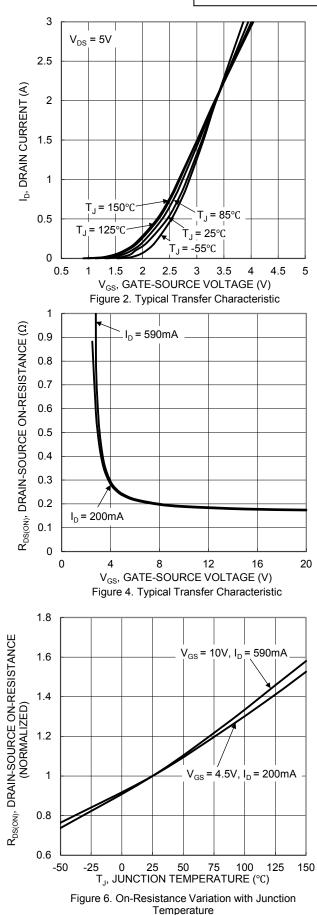
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						÷
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	V _{GS} = 0V, I _D = 250µA
Zero Gate Voltage Drain Current	IDSS	—	_	1.0	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.8	1.2	1.6	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		-	0.2	0.4	Ω	V _{GS} = 10V, I _D = 0.59A
Static Drain-Source On-Resistance	R _{DS(ON)}	—	0.3	0.7	Ω	V _{GS} = 4.5V, I _D = 0.2A
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	V _{GS} = 0V, I _S = 10mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}		50	_	pF	
Output Capacitance	C _{oss}	-	12	_	pF	−V _{DS} = 15V, V _{GS} = 0V, −f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	10	_	pF	
Gate Resistance	Rg	_	58	_	Ω	$V_{DS} = V_{GS} = 0V$, f = 1.0MHz
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	0.5	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	1.2	_	nC	V _{DS} = 10V, V _{GS} = 10V
Gate-Source Charge	Q _{gs}		0.2	_	nC	I _D = 250mA
Gate-Drain Charge	Q _{gd}	_	0.1	_	nC	7
Turn-On Delay Time	t _{D(ON)}	—	3.5		ns	
Turn-On Rise Time	t _R	_	3.3		ns	V _{GS} = 10V, V _{DS} = 30V,
Turn-Off Delay Time	t _{D(OFF)}	_	16.8		ns	I _D = 100mA, R _G = 25Ω
Turn-Off Fall Time	t _F	_	13.8		ns	7

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.



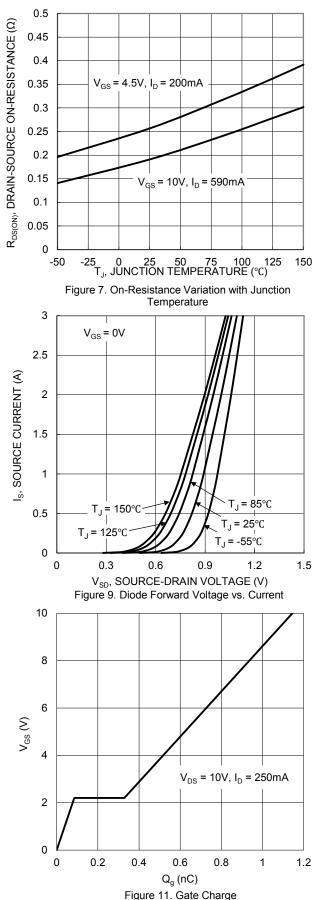
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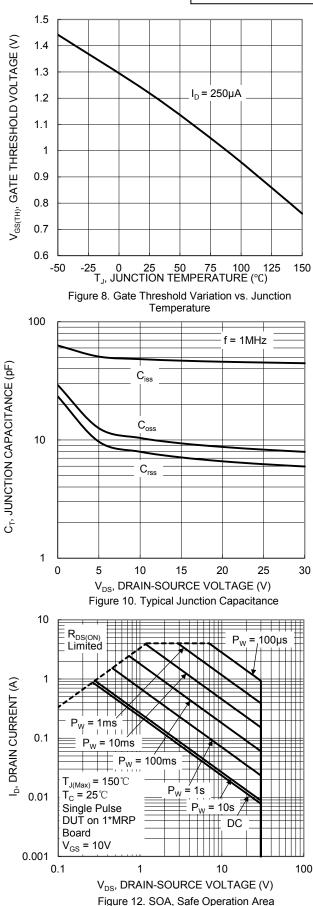




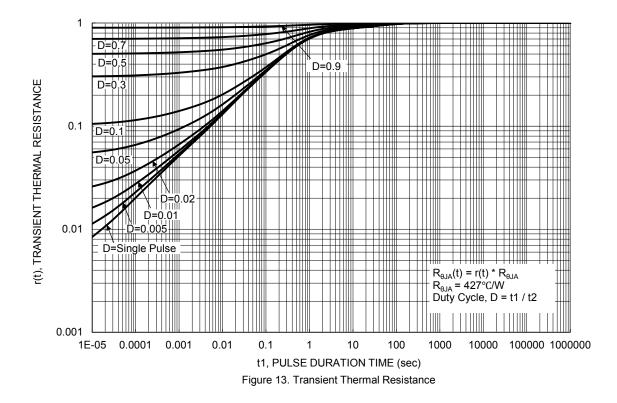








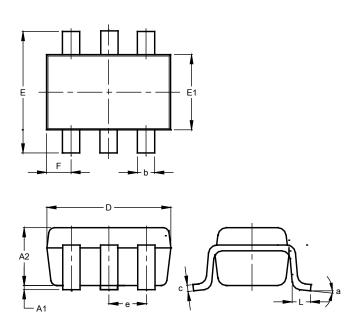






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

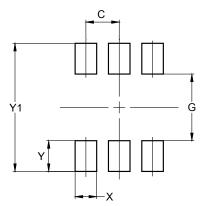


SOT363								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
e	0	.650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All I	Dimen	sions	in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500



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